

U.S.S.N. 10/696,825

ABSTRACT OF THE DISCLOSURE

~~[0004] A method of coating a semiconductor substrate material with a coating material consisting of the steps of mixing an adhesion promoter with a coating material and applying the mixture to a semiconductor substrate material. The invention also includes means for coating a semiconductor substrate material with a coating material comprising means for mixing adhesion promoters with coating materials and means for applying the mixture of adhesion promoters and coating materials to a semiconductor substrate. An article comprises a semiconductor substrate and a coating mixture on the semiconductor substrate. The coating mixture is comprised of adhesion promoter and photopolymer. The adhesion promoter contains α -amino propyltriethoxysilane in organic solution.~~